## 502383686 06/13/2013

#### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Masahiko ONISHI	06/04/2013

## RECEIVING PARTY DATA

Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.	
Street Address:	5-33, Kitahama 4-chome, Chuo-ku	
City:	Osaka-shi, Osaka	
State/Country:	JAPAN	
Postal Code:	5410041	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13993960

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	John G. Smith
Signature:	/John G. Smith/
Date:	06/13/2013

**Total Attachments: 1** 

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OP \$40.00

PATENT REEL: 030608 FRAME: 0468

ATTORNEY DOCKET NO.: SOLE/JOINT INVENTION (U.S. Rights Only)

# **ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have					
nade an invention entitled:  AMPLIFIER CIRCUIT AND WIRELESS COMMUNICATION EQUIPMENT  For which I/WE are filing an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on, (Serial No); and					
WHEREAS, Sumitomo Electric Industries, LTD., a corporation of Japan, whose post office address is 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 5410041 Japan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application or any application claiming priority based on this application;					
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, or any application claiming priority based on this application, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;					
AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, or any application claiming priority based on this application, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.					
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known.  IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).					
		Date			
ONISHI, Masahiko	Assignor's Signature Masahiko Onishi	June 4,2013			
Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku, Osaka-shi, Osaka 5540024 Japan		Citizenship JAPAN			
Full Name of Second Assignor	Assignor's Signature	Date			
Address:	I	Citizenship			
Names of additional inventors attached Yes No					

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**RECORDED: 06/13/2013** 

PATENT REEL: 030608 FRAME: 0469